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Pt nanocrystals formed by ion implantation: A defect-mediated nucleation process

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The influence of ion irradiation of SiO2 on the size of metal nanocrystals (NCs) formed by ion implantation has been investigated. Thin SiO2 films were irradiated with high-energy Ge ions then implanted with Pt ions. Without Ge irradiation, the largest Pt NCs were observed beyond the Pt projected range. With irradiation, Ge-induced structural modification of the SiO2 layer yielded a decrease in Pt NC size with increasing Ge fluence at such depths. A defect-mediated NC nucleation mechanism is proposed and a simple yet effective means of modifying and controlling the Pt NC size is demonstrated. © 2007 American Institute of Physics. [DOI: 10.1063/1.2777165]

Amorphous SiO2 is widely used in the fabrication of micro- and optoelectronic devices. Though this material has been the subject of intensive study, some details of the structural modifications induced by ion irradiation remain unclear. Examples of irradiation-induced modification include compaction of the implanted layer due to changes in the bond-angle and bond-length distributions and the formation of defect configurations including O-vacancy centers and nonbridging O-hole centers. Such processes are dominated by nuclear stopping or elastic interactions between the incident ion and target nuclei. At high irradiation energies, where the energy loss is dominated by electronic stopping or inelastic interactions between the incident ion and target electrons, additional irradiation-induced structural modifications can include anisotropic plastic deformation and latent track formation.

The use of amorphous SiO2 as a host material for metal nanocrystals (NCs) is also well established. Examples include SiO2 encapsulation after NC formation as well as NC formation within SiO2 by ion implantation. Advantages of the latter include controlling the depth and concentration of the implanted metal atoms and the protection afforded the NCs against oxidizing or corrosive environments. Ion irradiation of the SiO2 matrix subsequent to metal NC formation represents a means of altering the NC size distributions to better suit specific applications. In general, such applications are governed by the unique optical, catalytic, and therapeutic properties of metal NCs that can differ dramatically from those of their bulk counterparts. Finite size effects and the high proportion of surface atoms in a NC are responsible for these differences.

In this study, we investigate how defects produced in amorphous SiO2 by ion irradiation prior to metal NC formation can subsequently influence the size of Pt NCs formed by ion implantation. We note that Pt NC formation in SiO2 has received scant attention in the literature. High-energy Ge ion irradiation was used to generate a constant defect distribution over the extent of a thin SiO2 layer. Pt ions were then implanted into the structurally modified SiO2 layer and the size evolution of Pt NCs was measured as a function of the Ge-ion fluence. We show that Ge-ion irradiation yielded a significant reduction in mean Pt NC diameter and thus demonstrate a simple means of controlling the Pt NC size.

5 MeV Ge ions were implanted into amorphous, ~1.9 μm thick SiO2 films [thermally grown on (100) Si substrates] at liquid N2 temperature with ion fluences at the name of (1–50)×10¹⁵ ions/cm². Samples were then implanted with 4.5 MeV Pt ions, again at liquid N2 temperature, to a fluence of 1×10¹⁷ ions/cm². Following implantation, samples were annealed in forming gas (95% N2/5% H2) for 1 h at 1100 °C to promote NC growth.

The depth distributions of irradiated and implanted atoms and the number of vacancies generated by both Ge and Pt ions, as simulated by SRIM 2003, are plotted in Fig. 1. Clearly, the Ge atoms are located at depths far beyond the SiO2 layer (thus negating impurity effects), while the Pt atomic concentration has a maximum within the SiO2 layer at a depth of approximately 1.4 μm. Vacancy production by Ge ions is nearly constant over the extent of the SiO2 layer while, as expected, the maximum in Pt-induced vacancy production is at slightly lesser depths (~1.1 μm) than the atomic concentration maximum. The Pt atomic depth dis-

![Fig. 1.](Color online) Ge (5×10¹⁶ ions/cm²) and Pt (1×10¹⁷ ions/cm²) atomic depth distributions and vacancy production as simulated by SRIM. The inset shows the experimental Pt atomic depth distribution determined by RBS and TEM.

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distribution measured by Rutherford backscattering spectrometry (RBS) and estimated from transmission electron microscopy (TEM) measurements is shown in the figure inset.

Figure 2 displays the representative results obtained by TEM using a Philips CM300 microscope operating at 300 kV. The samples were prepared in cross-section geometry with the small-angle cleavage technique.22 Images in the same row represent different depths in the same sample, while different samples at the same depths are displayed vertically, with increasing Ge irradiation fluence from top to bottom. The top row shows the sample without Ge irradiation. The largest NCs formed at depths of 1.5–1.6 μm where the vacancy generation is dominated by Ge ion irradiation. The mean Pt NC diameter decreases with increasing Ge irradiation fluence at depths of 1.5–1.6 μm where the vacancy generation is dominated by Ge ion irradiation. The mean Pt NC diameter decreases as the total energy deposited in vacancy production increases. The mean diameter saturates at ~3 nm when the energy deposited in vacancy production exceeds ~2 × 10^{23} keV/cm^{3}.

Figure 3(a) shows the mean Pt NC diameter as a function of depth over the same region. For depths of 1.7–1.8 μm, the mean NC diameter decreases from ~5.5 to ~3.5 nm as the Ge irradiation fluence increases. At lesser depths (1.2–1.5 μm), a slight reduction in NC diameter with increasing Ge irradiation fluence is also apparent despite the vacancy production being dominated by Pt ion implantation. This may reflect Pt NC nucleation on Ge irradiation-induced defects during the early stages of the Pt implantation. Figure 3 thus demonstrates that Pt NC size is not governed by the Pt atomic concentration but by nuclear energy deposition.

Figure 3(b) shows the mean Pt NC diameter as functions of depth and Ge irradiation fluence for the same region shown in (a).
threshold values required for ion hammering and latent track formation in amorphous SiO$_2$ (~2 keV/nm) (Ref. 9) and irradiation-induced NC nucleation in Cu-oxide containing glass (~5 keV/nm).\textsuperscript{23} Nonetheless, the total energy deposited in electronic stopping processes is, like the total energy deposited in nuclear processes, sufficient to compact the SiO$_2$ layer.

Striking differences are apparent upon a comparison of Pt NC formation, as presented above, with earlier reports for Au (Ref. 24) and Cu (Ref. 25) NC formation. For the latter two metals, the largest NCs are observed at the atomic concentration maximum, in close proximity to the vacancy production maximum. In contrast, the largest Pt NCs observed herein are at the vacancy production minimum (in the absence of Ge ion irradiation). For comparable metal atomic concentrations and annealing conditions, Pt NCs are also significantly smaller than both Au and Cu NCs, again indicative of differences in the nucleation and/or growth processes. We thus speculate that Pt NCs preferentially nucleate on irradiation-induced defects resulting from nuclear energy deposition. A more detailed comparison of NC formation as a function of metal would necessitate consideration of differences in metal diffusivity (in the presence of irradiation-induced disorder), metal solubility, and metal/matrix interfacial energies.

As noted previously, irradiation-induced structural modifications of amorphous SiO$_2$ can be of many forms with examples that include compaction and the formation of O-vacancy centers. However, both the compaction\textsuperscript{3} and O-vacancy center concentration\textsuperscript{4} saturate when the energy deposited in vacancy production exceeds \( \sim 10^{23} \) keV/cm$^3$, three orders of magnitude less than that observed herein for the mean Pt NC diameter. The observations presented in this study are unlikely the result of a single defect configuration but most probably relate to an ensemble of irradiation-induced structural modifications. A final irradiation-induced structural modification for consideration is the potential influence of atoms, both Si and O, recoiled from the SiO$_2$ layer by Ge-ion irradiation. The resulting imbalance in vacancy/interstitial concentrations and stoichiometry (both microscopic and macroscopic) may also influence Pt NC nucleation. Furthermore, such effects may not saturate\textsuperscript{26} for the given Ge-ion fluence range.

In summary, we have investigated the influence of ion irradiation of SiO$_2$ on the mean diameter of Pt NCs. Without ion irradiation, the largest Pt NCs (~5.5 nm) formed at the atomic concentration and vacancy production minima, in contrast to other metals. With ion irradiation prior to NC formation, the mean Pt NC diameter decreased as the irradiation fluence increased. Saturation of the NC diameter at \( \sim 3 \) nm was observed when the energy deposited in vacancy production reached \( \sim 2 \times 10^{23} \) keV/cm$^3$. We suggest Pt NCs readily nucleated on irradiation-induced disorder, the nature of which was not identified but was unlikely to be a single defect configuration. High-energy ion irradiation of SiO$_2$ prior to Pt NC formation, producing a near-constant concentration of irradiation-induced vacancies over the extent of the SiO$_2$ layer, yielded a much more uniform Pt NC size distribution and thus represents an effective means of tailoring the Pt NC diameter.

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